



Material Content Data Sheet



Sales Product Name		ICE2QR4780G		Issued		25. September 2017			
MA#		MA001589902							
Package		PG-DSO-12-19		Weight*		155.13 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	2.594	1.67	1.67	16720	16720	
leadframe	inorganic material	phosphorus	7723-14-0	0.017	0.01		112		
		non noble metal	zinc	7440-66-6	0.069	0.04		447	
		non noble metal	iron	7439-89-6	1.386	0.89		8936	
wire	noble metal	non noble metal	copper	7440-50-8	56.286	36.28	37.22	362840	372335
		noble metal	gold	7440-57-5	0.247	0.16	0.16	1590	1590
		organic material	carbon black	1333-86-4	0.276	0.18		1777	
encapsulation	plastics	epoxy resin	-	10.751	6.93		69305		
		inorganic material	silicondioxide	60676-86-0	80.862	52.14	59.25	521265	592347
leadfinish	non noble metal	tin	7440-31-5	1.143	0.74	0.74	7366	7366	
plating	noble metal	silver	7440-22-4	0.428	0.28	0.28	2762	2762	
glue	plastics	epoxy resin	-	0.160	0.10		1032		
		noble metal	silver	7440-22-4	0.907	0.58	0.68	5848	6880
*deviation	< 10%				Sum in total:		100.00	1000000	

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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